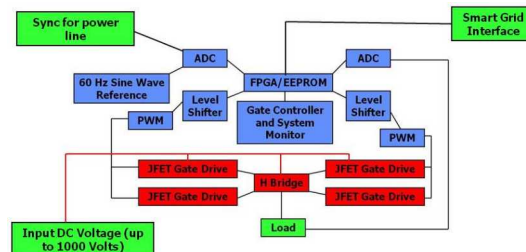
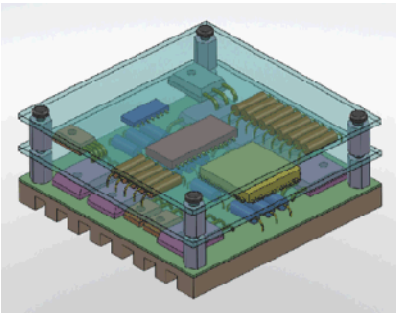


Development of an Integrated Power Controller Based on HT SOI and SiC

Joseph A. Henfling, Stan Atcitty, Frank Maldonado, Sandia National Laboratories



Sandia National Laboratories is a multiprogram laboratory operated by Sandia Corporation, a Lockheed Martin company, for the United State Department of Energy under contract DE-AC04-94AL85000.

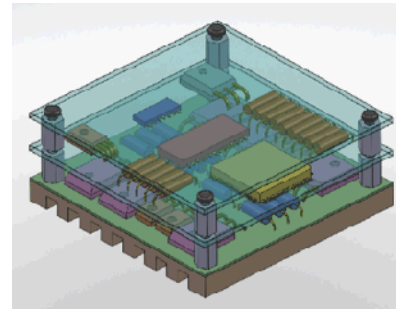


Overview

- **Program Goals for HT Power Controller**
 - Size reduction of power controllers
 - Ultimately a single module solution
- **Power Controller Design Details**
 - Two options investigated
 - APEI's HT SOI MOSFET power module
 - Sandia's JFET power module
- **Test Results**
- **Conclusions**
- **Future work**

Project Goals

- **Design HT power controller that can be integrated into a single module**
 - **Benefits include:**
 - **Size reduction of power controllers**
 - Integration of the SOI based controller with (near) SiC power devices
 - **Ease thermal management requirements**
 - **Increase reliability**
 - Designed using HT components and elimination of board-level interconnects
 - **Increase efficiency**
 - Optimized to fully exploit the benefits of using SiC technology in power controllers
 - Higher breakdown voltage coupled with a lower “ON” resistance can reduce energy losses by 3-4%
 - **High voltage capable designs (SiC JFET’s rated at 1200 Volts)**
- **Establish commercialization path to quicken the adaptation of energy-saving SiC technology**



Phase 3

Why a Single Module Solution?

+/-150MVar STATCOM
Northeast Utilities' Glenbrook
Substation in Stamford, CT



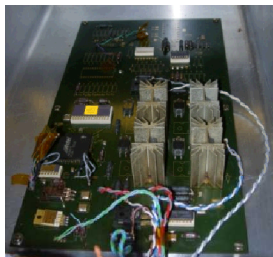
Cooling
Pipes

Cooling System:
Pump, Pipes



GTOs &
Controls

7" x 12.5"



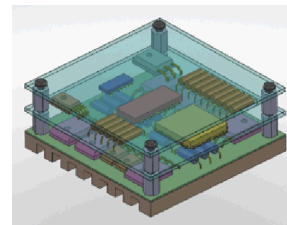
Phase 1

2.5" x 8.75" x 3.5"



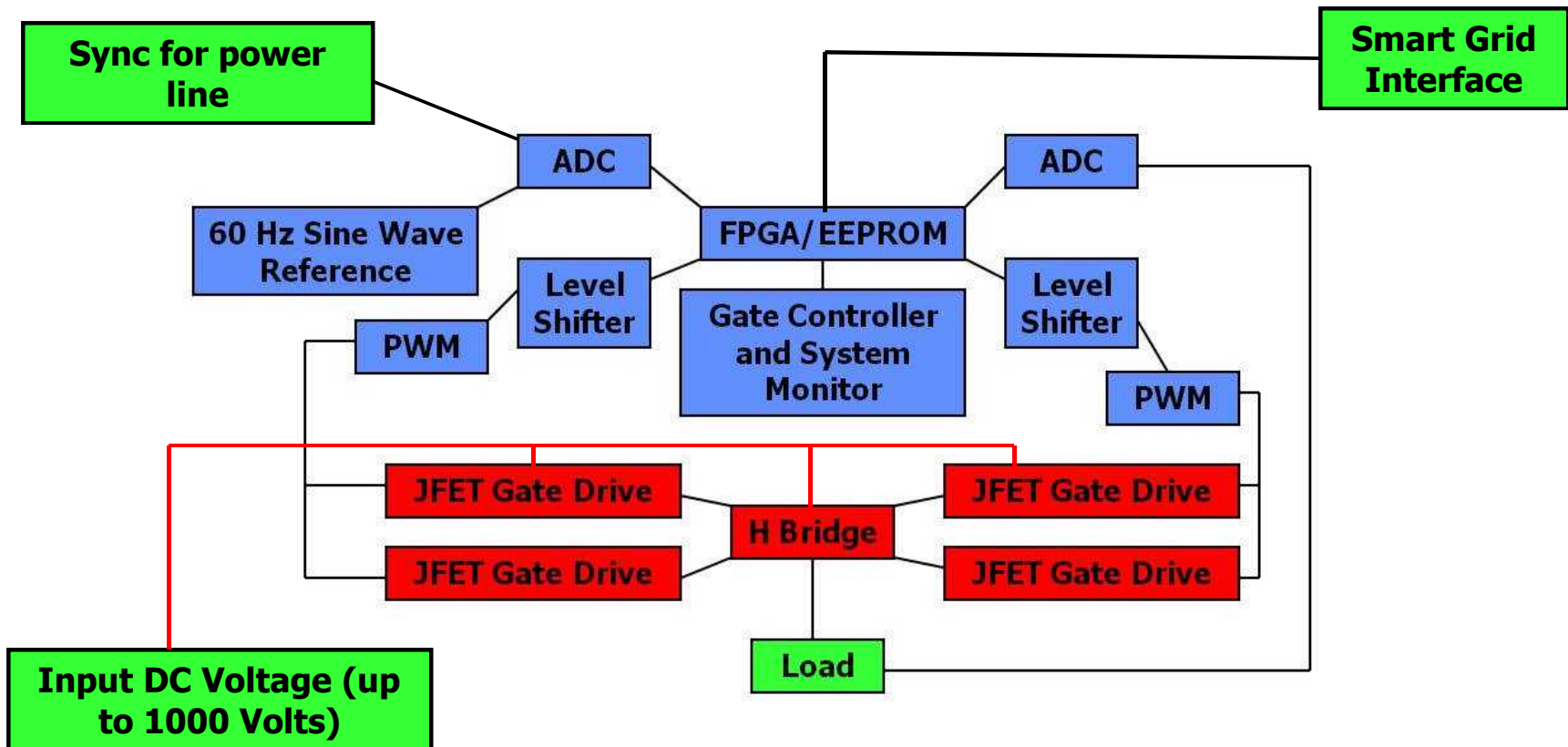
Phase 2

4" x 4" x 2"



Phase 3

Block Diagram of the Power Controller



$$V_{out} = V_{in} (1 - \text{Duty Cycle})$$

Blue – MCM 1

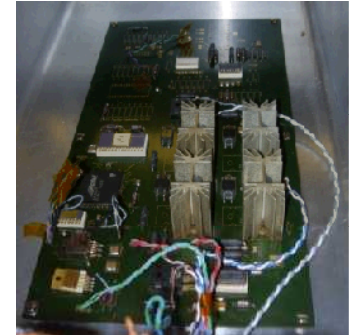
Red – MCM 2

Green – Outside Components

Phase I Accomplishments

Program Start Date FY09

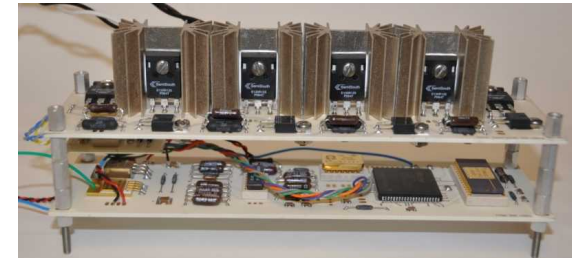
- **Successfully demonstrated a prototype microcontroller-based HT power controller at 240C**
 - Basic control capabilities including monitoring the JFET (Junction Field Effect Transistor) case temperature
 - Safely shutting the system down if a programmed temperature was exceeded
- **Demonstrated high side / low side SOI (Silicon-on-Insulator) gate drive for the JFET power devices**
- **Successfully tested SOI MESFET (Metal-Semiconductor-Field-Effect-Transistor) gate drive**



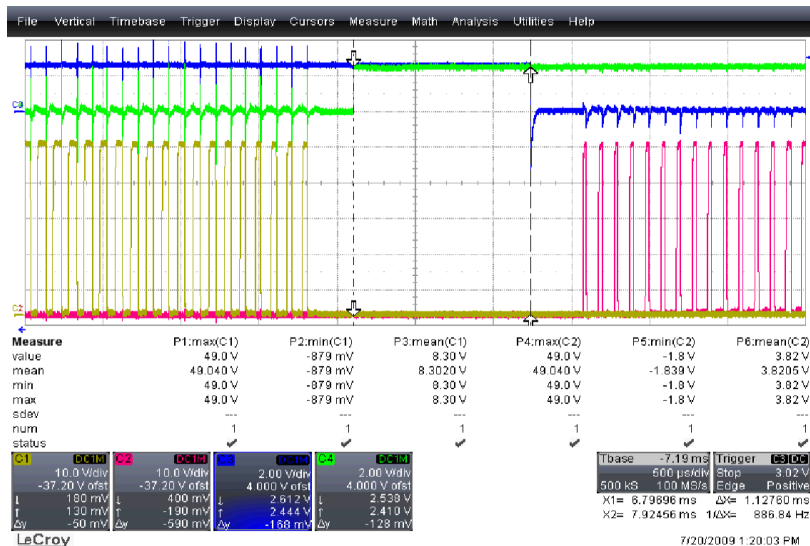
By combining SOI control and drive circuits with SiC, an intelligent system capable of operation up to 240°C (JFET junction temperature approaching 300°C) was successfully demonstrated

Phase II and III Accomplishments

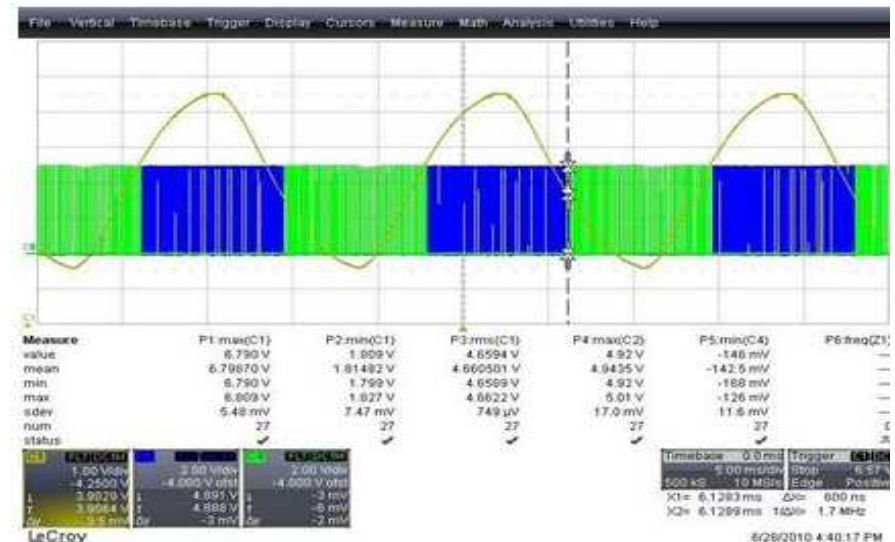
- **“Fine-Tune” prototype design**
 - Designed, fabricated and tested a version 2 board with optimized system efficiency
 - Enhanced high side gate drive of the H bridge
 - Mitigated the current spikes
 - Minimized the switching “dead time”
 - Optimized the output filter
 - Improved microcontroller design
 - Better control of the power devices
 - Active feedback investigated; refinement required
- **Started evaluation of APEI’s power module**
 - Verified compatibility with Sandia’s controller
 - Performed 5 kW tests at APEI (room temperature)
 - Initiated oven tests with modules
- **Contracted with Honeywell to program HT FPGA with Sandia developed code – in progress**
- **Contracted with Life Bioscience to fabricate HT circuit board – in progress**



Enhanced Performance – Reduced Dead Band



Scope image depicting the gate drive for the H bridge:
Yellow trace is high side A, blue is low-side B, red is high-side B and green is low-side A



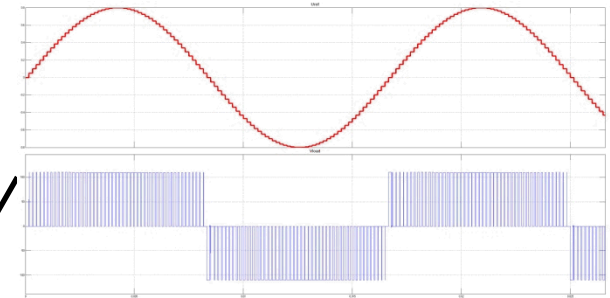
Present design has a 600ns dead band

Prototype design exaggerated the dead band between cycles to ensure the JFETs were not damaged due to timing issues. This substantially reduced the overall efficiency.

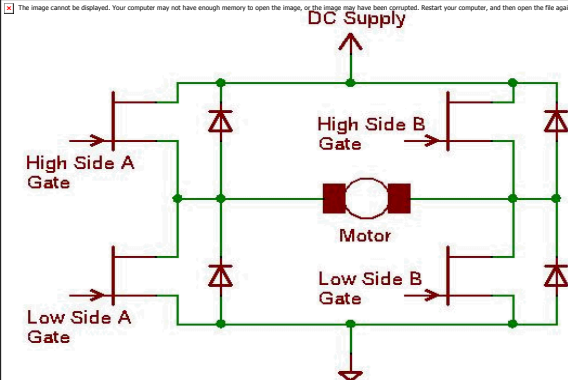
Enhanced Performance - Improved Gate Drive

- **Enhanced switching methodology**
 - **Three-level continuous PWM**
 - **Voltage harmonics are both decreased in amplitude and increased in frequency**
 - Reduced output filter size requirements (to achieve a given current THD)
 - Increased efficiency

Simulink Simulation



The image cannot be displayed. Your computer may not have enough memory to open the image, or the image may have been corrupted. Restart your computer, and then open the file again. If the red x still appears, you may have to delete the image and then insert it again.



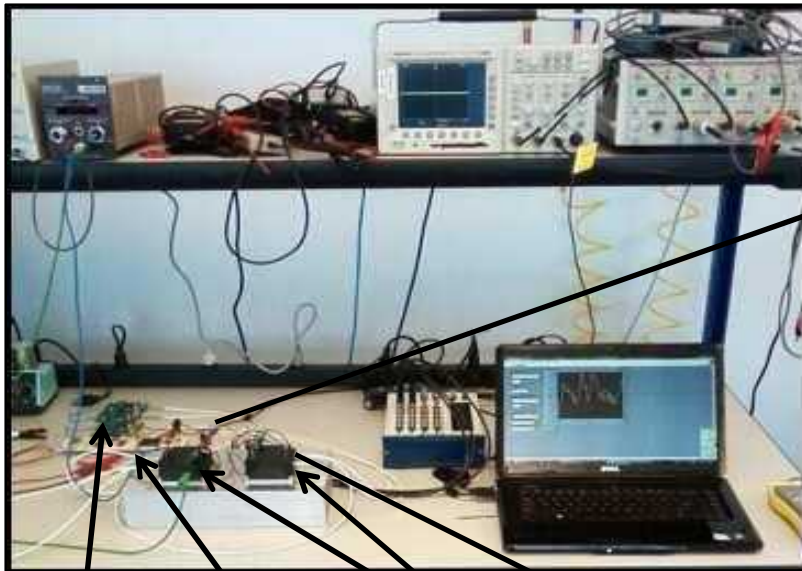
Prototype had PWM Gate Drive at Q1 and Q3; 60Hz at Q2 and Q4; Discontinuous PWM



Gold – Reference signal,
Red – current waveform,
Yellow – resulting voltage waveform

Enhanced circuit has PWM Gate Drive at Q1, Q2, Q3 and Q4; Three-level continuous PWM

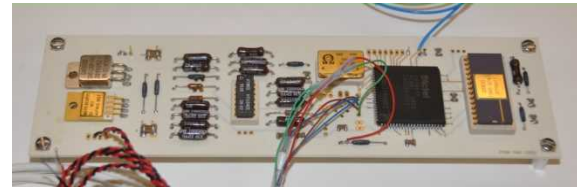
Test Results – Initial Testing at APEI



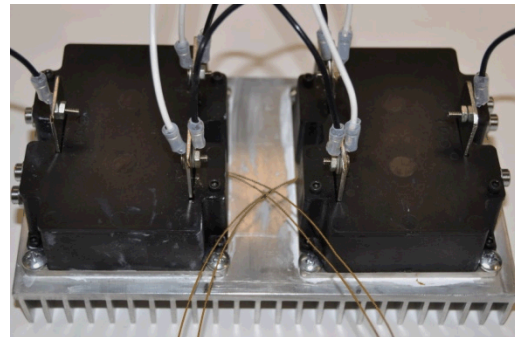
APEI
Power
Supplies

Sandia
Controller

APEI
Modules



Sandia Controller

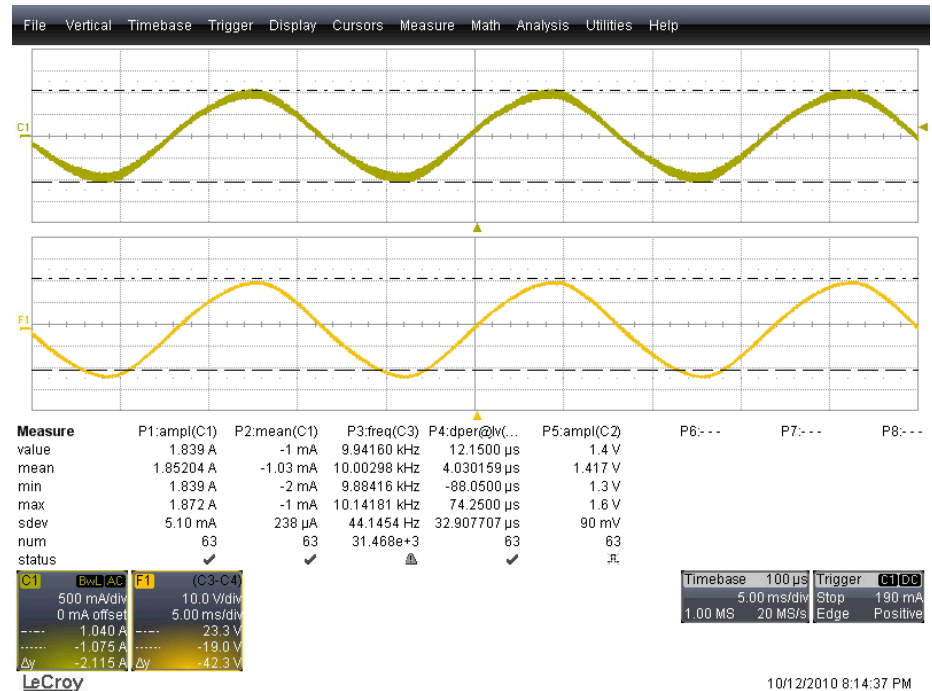


APEI Power
module with
integrated
gate drive

APEI Test Results



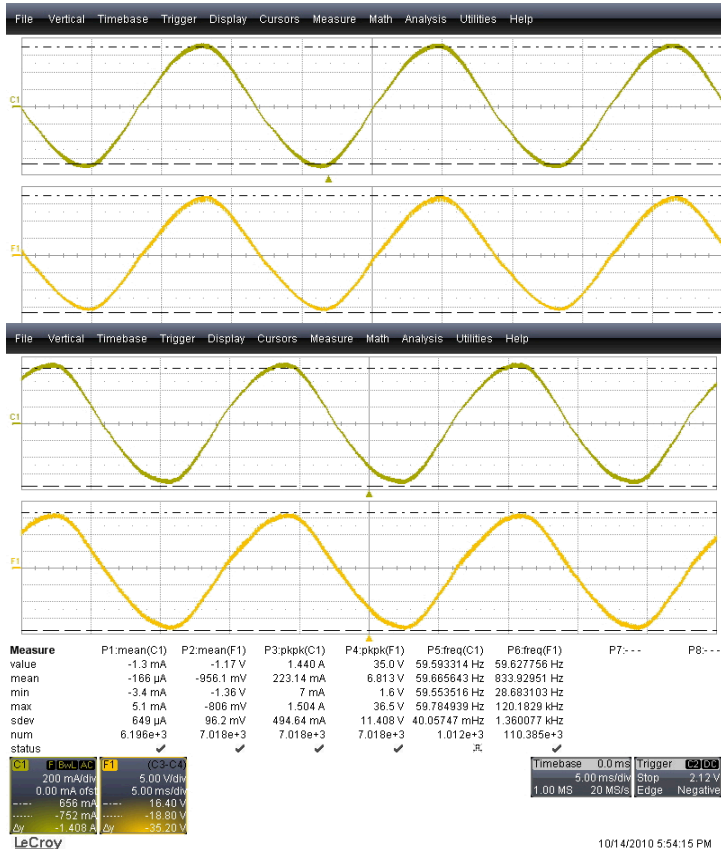
Test Results at 150 C



Testing APEI modules with Sandia's controller
at elevated temperatures

Testing Sandia's Controller with JFET Power Devices

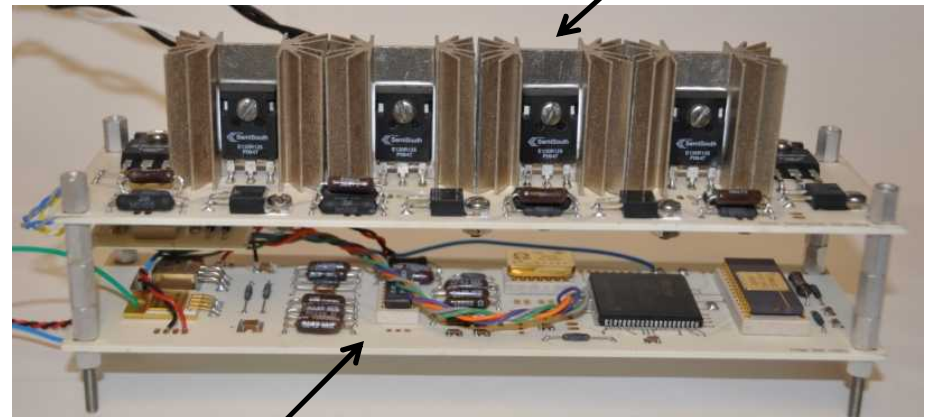
Resulting waveform at room temperature



Resulting waveform at 200°C

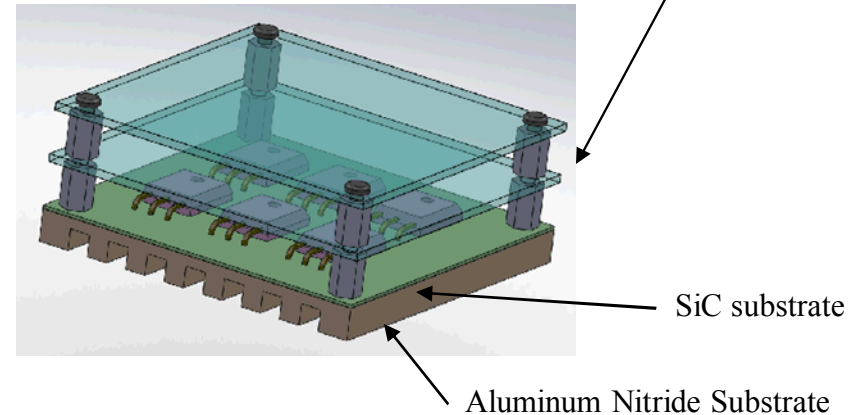
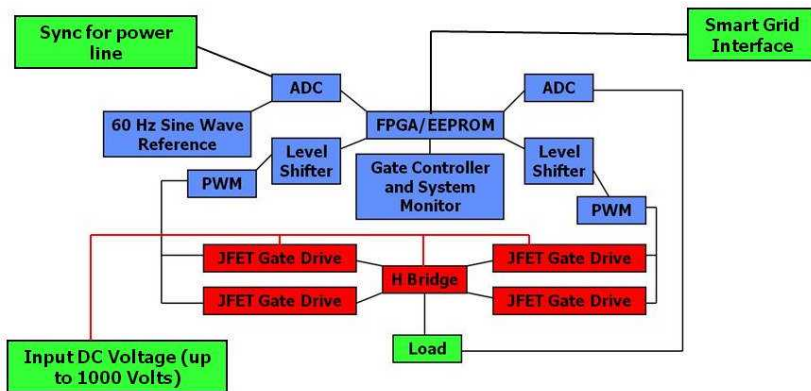


JFET Power
Devices and
Gate Drive



Controller

Updated Concept of the Power Controller Module



Investigating potentially utilizing same substrate for power devices and MultiChip Modules (MCM)



Future Plans

- **Evaluate APEIs HT gate drive power supplies**
- **Investigate utilizing APEI's JFET power module with HT gate drive power supply and steps required to integrate into single module**
- **Refine feedback control**
- **Complete MCM design of controller**
- **Evaluate Honeywell HT SOI FPGA**
- **Evaluate HT circuit board**
- **Demonstrate “next step” in single module solution (Sandia or APEI power boards)**



Conclusion

- **Lab tested an enhanced controller board and a power board consisting of JFET power devices with gate drive**
- **Completed initial testing at APEI using APEI's power modules, LT gate drive power supply and Sandia's controller; 5kW tests**
- **Completed initial testing at Sandia at elevated temperatures**
- **In progress: conversion of Sandia code into a HT FPGA (Honeywell)**
- **In progress: fabrication of HT circuit board**



Collaborative Effort with Academia and Industry

- **DOE Funded**

- **Participants include:**

- **Sandia (Lead)**
 - **ASU (Circuit simulation, fabrication of test circuits using HT MESFET – JFET gate drive) - Phase I**
 - **PermaWorks (Inverter design simulation and fabrication of HV supply) – Phase I**
 - **APEI (Power modules, HT power supplies, thermal analysis) – Phase II, III**
 - **Life BioScience (HT circuit boards) – Phase II, III**

- **COTS suppliers**

- **Honeywell SSEC**
 - **Cissoid**
 - **SemiSouth**

The authors would like to thank DOE Energy Program and Imre Gyuk for financial support of this research.